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(54) Title: WATER-ABSORBENT RESIN COMPOSITION AND METHOD FOR PRODUCING THEREOF, AND ABSORBENT  
MATERIAL AND ABSORBENT PRODUCT USING THEREOF

(57) Abstract: A water-absorbent resin composition suffering exfoliation of additives from a water-absorbent resin only insignifi-  
cantly and excelling in fluidity of powder after absorption of moisture and in deodorizing property and absorbent property as well is  
provided. The water-absorbent resin composition of this invention comprises water-absorbent resin obtainable by polymerizing an  
unsaturated monomer having an acid group and/or a salt thereof; and complex oxide hydrate containing zinc and silicon, or zinc and  
aluminum, wherein the complex oxide hydrate contains zinc as main metal component, the mass ratio of the content of zinc and the  
content of silicon or aluminum is in the range of 50/50 - 99/1, and the absorption capacity at 60 minutes toward 0.90 mass% sodium  
chloride aqueous solution under the pressure of 1.9 kPa is not less than 20 g/g.



WO 2005/010102 A1